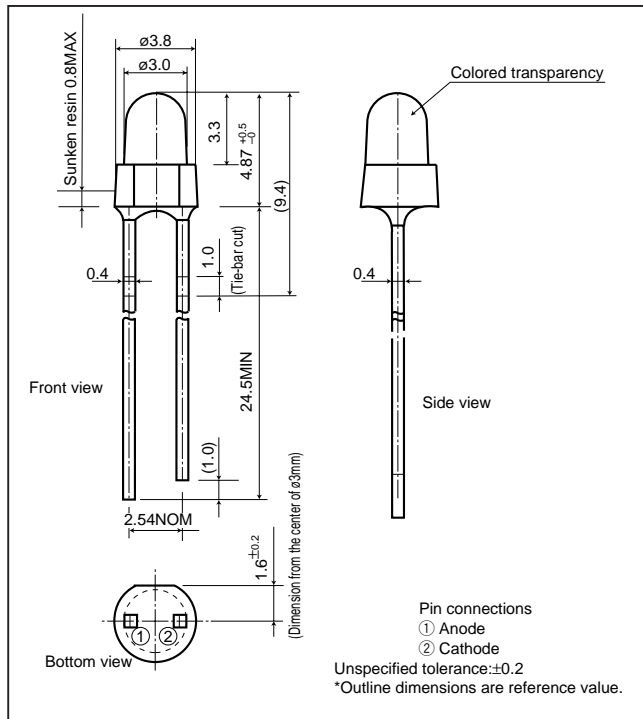


GL3Z□802B0S series

Viewing Angle: 80° (2θ1/2) ø3mm,
Cylinder Type, Colorless
Transparency Super-luminosity
LED Lamps for Outdoor Use

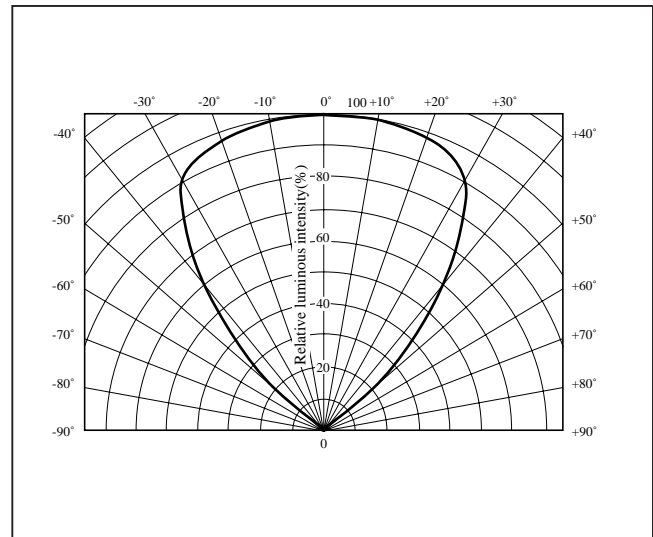
■ Outline Dimensions

(Unit : mm)



■ Radiation Diagram

(Ta=25°C)



■ Absolute Maximum Ratings

(Ta=25°C)

Model No.	Radiation color	Radiation material	Power dissipation P (mW)	Forward current IF (mA)	Peak forward current IFM*1 (mA)	Derating factor (mA/°C)		Reverse voltage VR (V)	Operating temperature Topr (°C)	Storage temperature Tstg (°C)	Soldering temperature Tsol*2 (°C)
						DC	Pulse				
GL3ZJ802B0S	Orange	AlGaInP on GaAs	130	50	100	0.67	1.33	5	-40 to +85	-40 to +100	260
GL3ZS802B0S	Sunset orange	AlGaInP on GaAs	130	50	100	0.67	1.33	5	-40 to +85	-40 to +100	260
GL3ZV802B0S	Amber	AlGaInP on GaAs	130	50	100	0.67	1.33	5	-40 to +85	-40 to +100	260
GL3ZE802B0S	Yellow-green	AlGaInP on GaAs	130	50	100	0.67	1.33	5	-40 to +85	-40 to +100	260

*1 Duty ratio=1/10, Pulse width=0.1ms

*2 5s or less (At the position of 1.6mm or more from the bottom face of resin package)

■ Electro-optical Characteristics

(If=20mA, Ta=25°C)

Lens type	Model No.	Forward voltage VF(V)		Peak emission wavelength λp(nm)	Dominant wavelength λd(nm)	Luminous intensity IV(mcd)	Spectrum radiation bandwidth Δλ(nm)	Reverse current		Terminal capacitance		Page for characteristics diagrams
		TYP	MAX	TYP	TYP	TYP	TYP	IR(μA) MAX	VR (V)	Ct(pF) TYP	(MHz)	
Colorless transparency	GL3ZJ802B0S	2.1	2.6	627	618	360	15	100	4	60	1	142
	GL3ZS802B0S	2.1	2.6	609	605	450	15	100	4	60	1	143
	GL3ZV802B0S	2.1	2.6	591	588	330	15	100	4	60	1	144
	GL3ZE802B0S	2.1	2.6	570	570	80	15	100	4	60	1	144

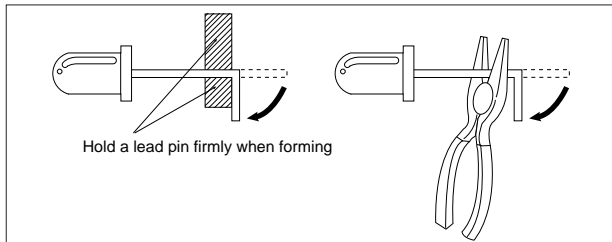
General Description of Light Emitting Diodes

A: Lead Pin Type

■ Lead Forming Method

Avoid forming a lead pin with the lead pin base as a fulcrum: be sure to hold a lead pin firmly when forming.

Lead pins should be formed before soldering.



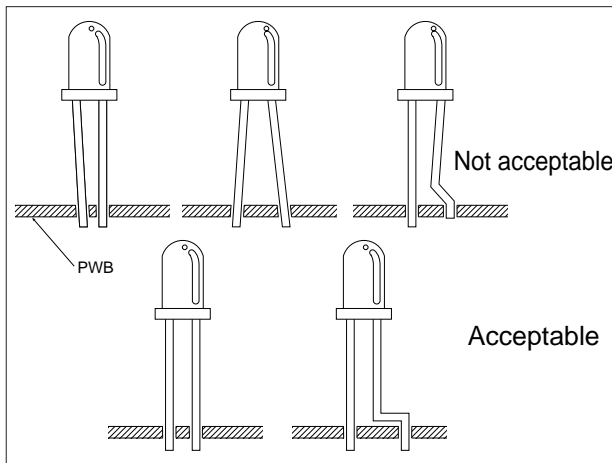
■ Installation

(1) Installation on a PWB

When mounting an LED lamp on a PWB, do not apply physical stress to the lead pins.

(Notes) • The lead pin pitch should match the PWB pin-hole pitch: absolutely avoid widening or narrowing the lead pins.

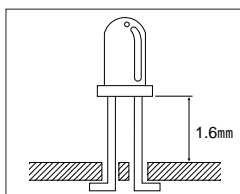
• When positioning an LED lamp, basically employ an LED with tie-bar cut or use a spacer.



(2) When an LED lamp is mounted directly on a PWB

If the bottom face of an LED lamp is mounted directly on single-sided PWB, the base of the lead pins may be subjected to have physical stress due to PWB warp, cutting or clinching of lead pins. Prior to use, be sure to check that no disconnection inside of the resin or damage to resin etc., is found.

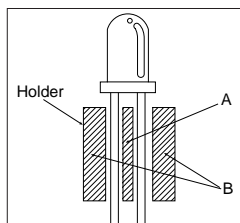
When an LED lamp is mounted on a double-sided PWB, the heat during soldering affects the resin; therefore, keep the LED lamp more than 1.6mm afloat above the PWB.



(3) Installation using a holder

During an LED lamp positioning, in case of using a holder, holder A should be designed to be smaller than the inside diameter of lead pins. Holder B should be designed to be larger than the outside diameter of lead pins.

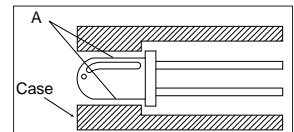
(Notes) • Pay attention to the thermal expansion coefficient of the material used for the holder. Since the holder expands and contracts due to preheat and soldering heat, mechanical stress may be applied to the lead pins, resulting in disconnection.



(4) Installation to the case

Do not fix part A with adhesives when fixed to the case as shown in the figure.

A hole of the case should be designed not to be smaller than the outside diameter of LED lamp resin.



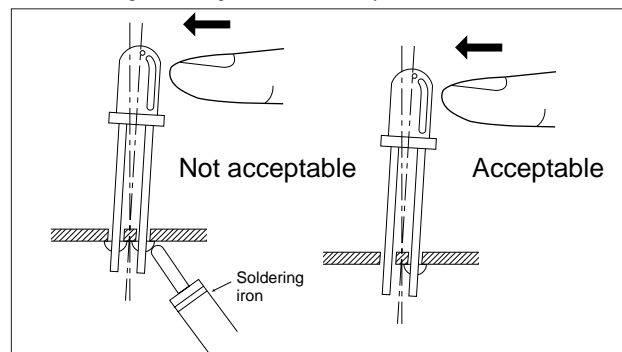
■ Soldering Conditions

Solder the lead pins under the following conditions.

Type of Soldering	Conditions
1. Manual soldering	295°C ± 5°C, within 3 seconds
2. Wave soldering	260°C ± 5°C, within 5 seconds
3. Reflow soldering	Preheating 70°C to 80°C, within 30 seconds Soldering 245°C ± 5°C, within 5 seconds

(Notes) • Avoid dipping resin into soldering bath.

• Avoid applying stress to lead pins while they are heated. For example, when the LED lamp is moved with the heat applied to the lead pins during manual soldering or solder repair, disconnection may occur.



■ Cleaning

(1) Solvents

The package resin may be penetrated by solvents used in cleaning. Refer to the table below for usable solvents.

Solvent	Usable
Ethyl alcohol	○
Isopropyl alcohol	○
Chlorosen	×
Acetone	×
Trichloroethylene	×

○ : Acceptable

× : Not acceptable

(Notes) • There is a world-wide movement to restrict the use of chlorofluorocarbon (CFC) based solvents and we recommend that you avoid their use. However, before using a CFC substitute solvent, carefully check that it will not penetrate the package resin.

(2) Cleaning Methods

Cleaning Method	Usable	Remarks
Solvent cleaning	○	Immersion up to one minute at room temperature
Ultrasonic cleaning	△	Test the cleaning under actual conditions and check for abnormalities before actual use.

○ : Acceptable

△ : Acceptability depends on device type and conditions

(Notes) • The affect on the device from ultrasonic cleaning differs depending on the size of the cleaning bath, ultrasonic output, duration, board size and device mounting method. Test the cleaning method under actual conditions and check for abnormalities before actual use.

• Cleaning with water is not allowed with the lead pins resin-tubulated: water may remain, thus causing rust to the lead pins.

• Please contact our representative before using a cleaning solvent or method not given above.

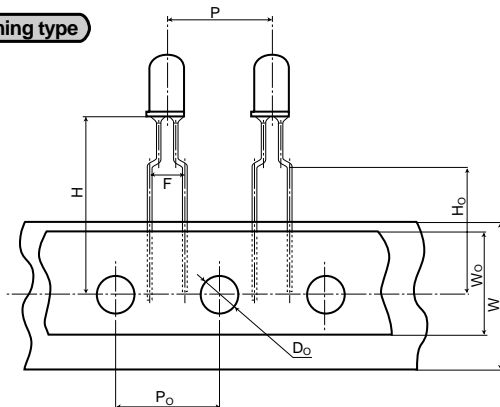
Tape-packaged Products

General Description

Sharp can supply tape-packaged LED lamps for automatic mounting. They will contribute to the high-efficiency mounting, high-precision, power saving. Please confirm before use because some products are not available in taping package.

Taping specification(Unit : mm)

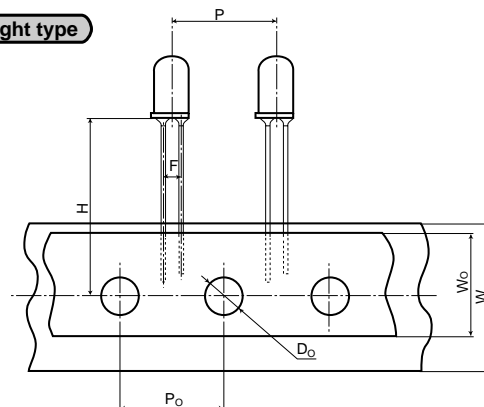
Forming type



Parameter	Symbol	A	B	D
Case end height	H*1	23.35	19.5	21.5
Lead clinch height	H ₀	16.0 ^{+0.5} _{-0.5}		
Tape width	W	18.0 ⁺¹ _{-0.5}		
Adhesive tape width	W ₀	13.0 ^{+0.3} _{-0.3}		
Product pitch	P	12.7 ^{±1}		
Sprocket hole pitch	P ₀	12.7 ^{±0.3}		
Lead pitch	F	5.0 ^{+0.8} _{-0.2}		
Sprocket hole diameter	D ₀	ø4.0 ^{±0.2}		

*1. Tolerance : ±1mm

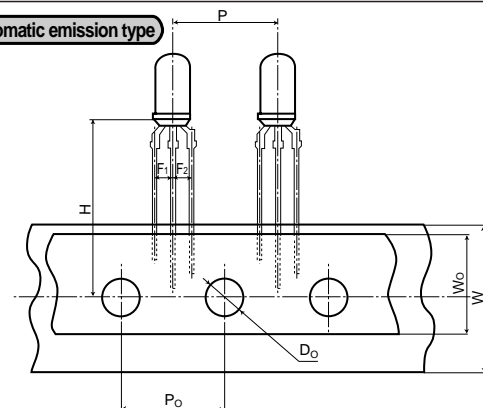
Straight type



Parameter	Symbol	P	W
Case end height	H*1	18.0	23.35
Lead clinch height	H ₀	—	
Tape width	W	18.0 ⁺¹ _{-0.5}	
Adhesive tape width	W ₀	13.0 ^{±0.3}	
Product pitch	P	12.7 ^{±1}	
Sprocket hole pitch	P ₀	12.7 ^{±0.3}	
Lead pitch	F	2.54NOM	
Sprocket hole diameter	D ₀	ø4.0 ^{±0.2}	

*1. Tolerance : ±1mm

Dichromatic emission type



Parameter	Symbol	Size (mm)
Case end height	H*1	19.5 ^{±1.0}
Lead clinch height	H ₀	—
Tape width	W	18.0 ^{+1.0} _{-0.5}
Adhesive tape width	W ₀	13.0 ^{±0.3}
Product pitch	P	12.7 ^{±1.0}
Sprocket hole pitch	P ₀	12.7 ^{±0.3}
Lead pitch	F ₁ , F ₂	2.54NOM
Sprocket hole diameter	D ₀	ø4.0 ^{±0.2}

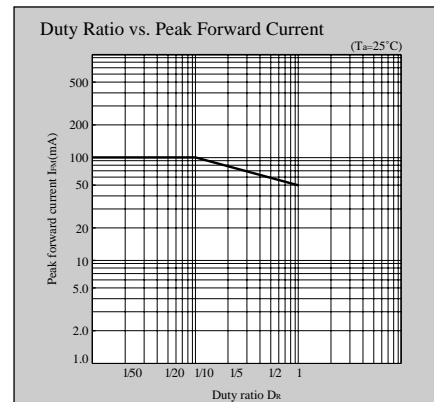
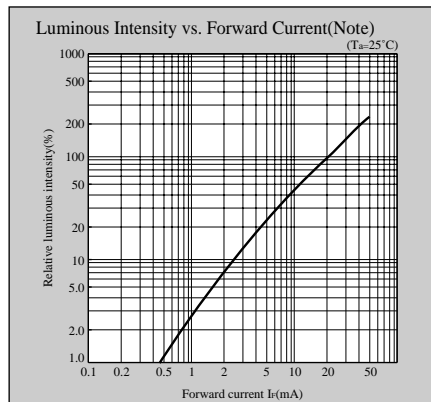
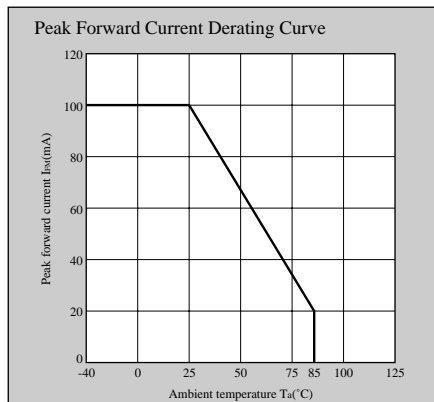
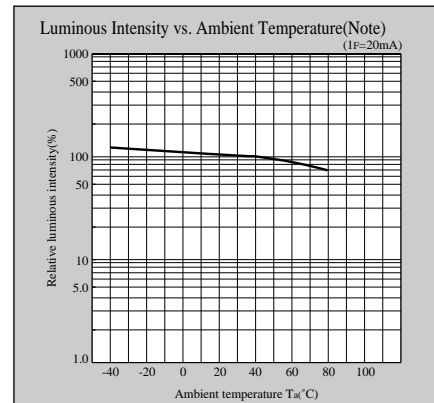
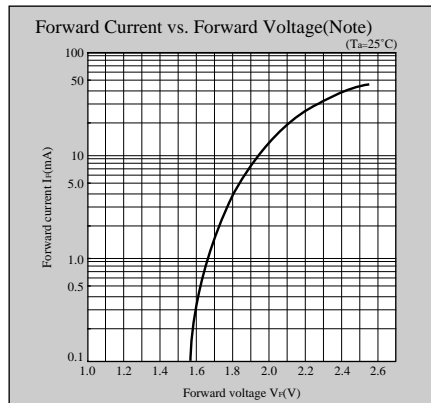
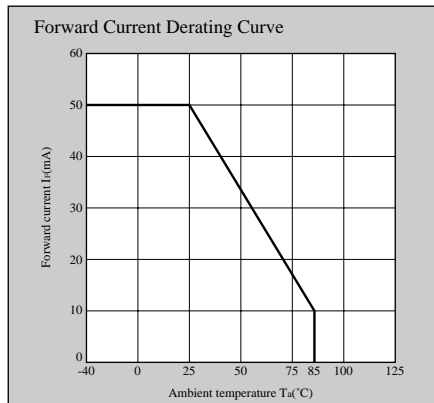
*1. Tolerance : ±1mm

NOTICE

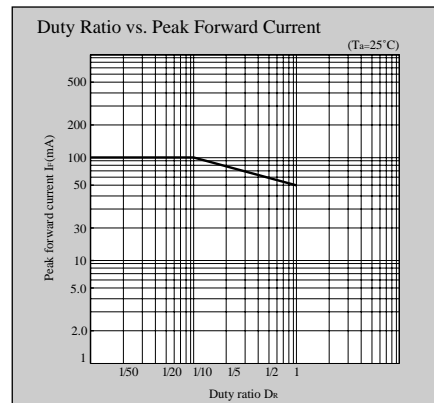
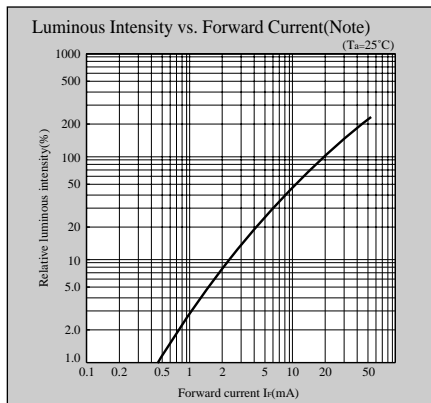
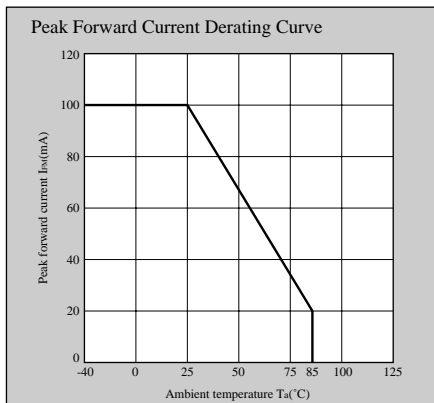
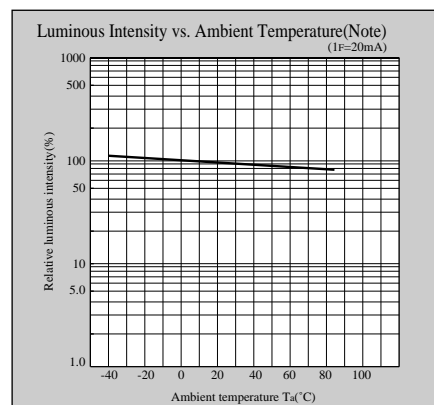
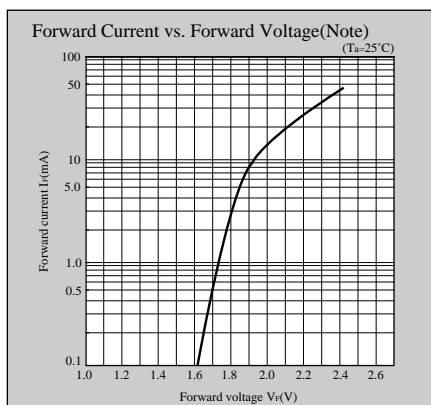
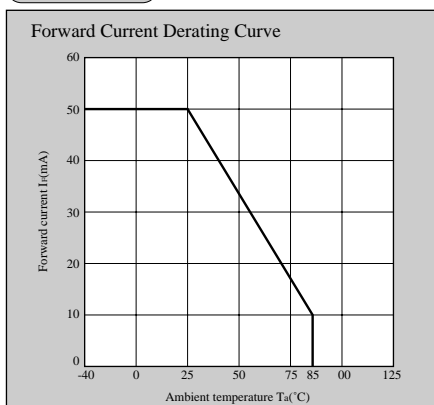
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 - Gas leakage sensor breakers
 - Alarm equipment
 - Various safety devices, etc.
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LED Lamp Characteristics Diagrams

ZR series



ZJ series

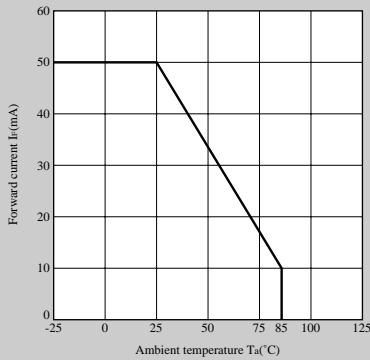


Note) Characteristics shown in diagrams are typical values. (not assurance value)

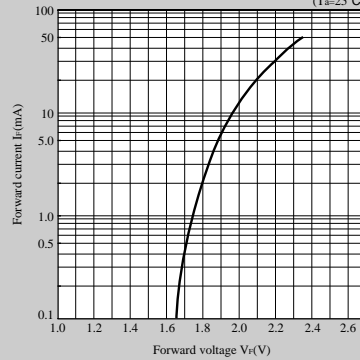
LED Lamp Characteristics Diagrams

ZS series

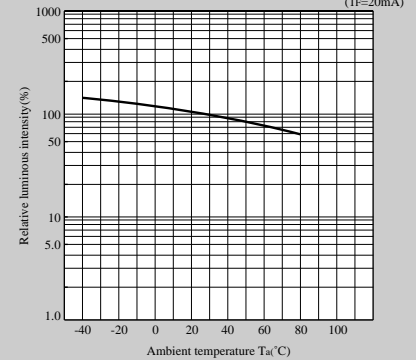
Forward Current Derating Curve



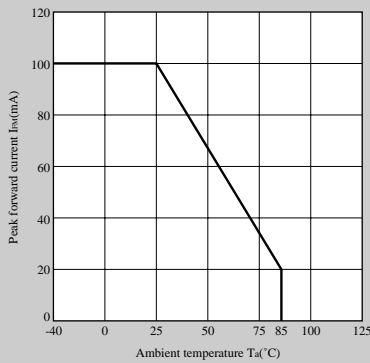
Forward Current vs. Forward Voltage(Note)



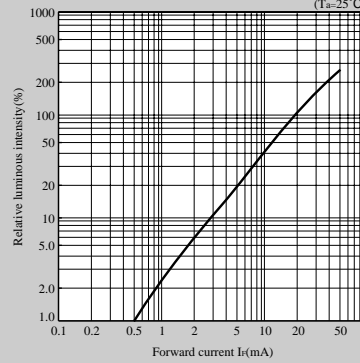
Luminous Intensity vs. Ambient Temperature(Note)



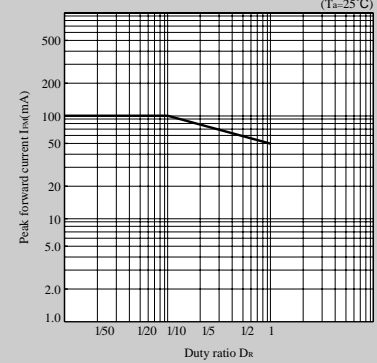
Peak Forward Current Derating Curve



Luminous Intensity vs. Forward Current(Note)

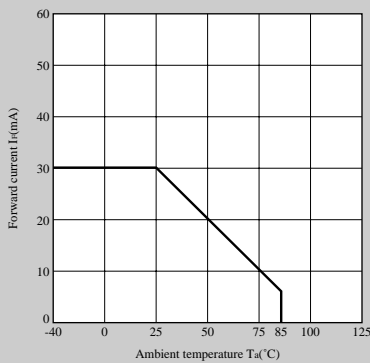


Duty Ratio vs. Peak Forward Current

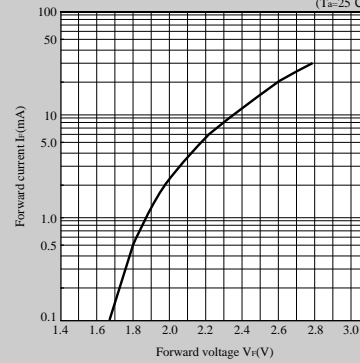


GL5XS022BOS

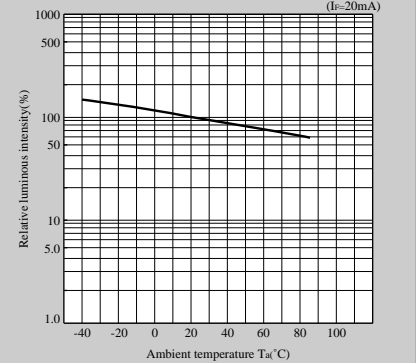
Forward Current Derating Curve



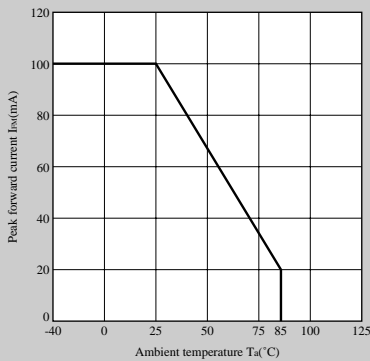
Forward Current vs. Forward Voltage(Note)



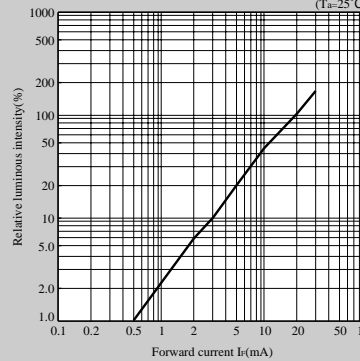
Luminous Intensity vs. Ambient Temperature(Note)



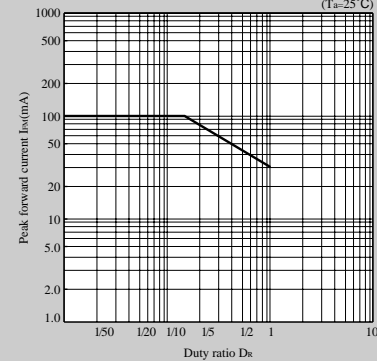
Peak Forward Current Derating Curve



Luminous Intensity vs. Forward Current(Note)



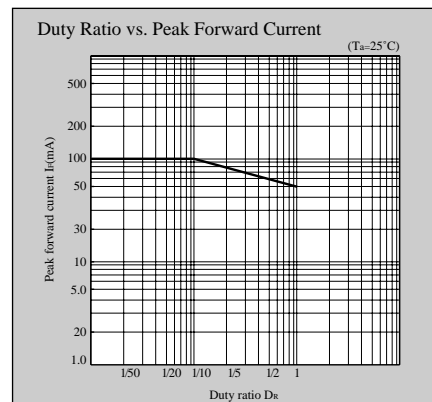
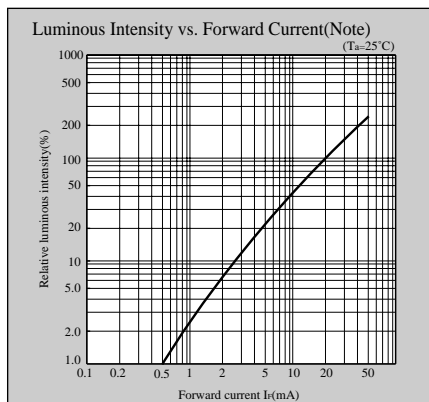
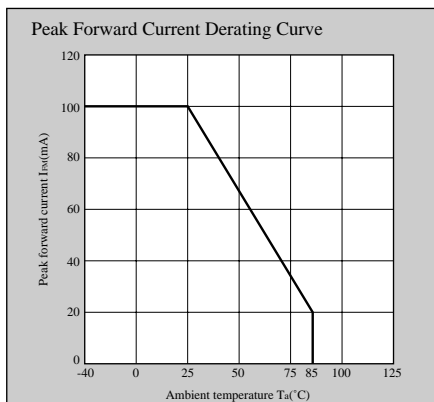
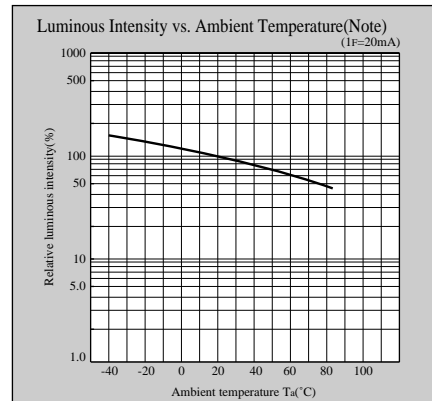
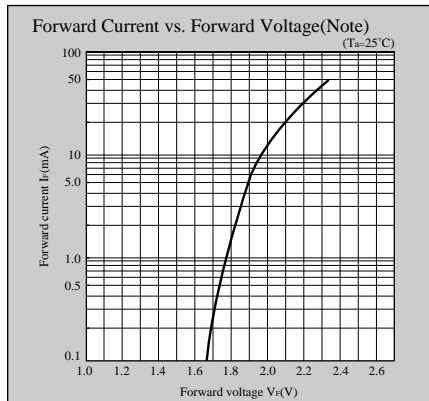
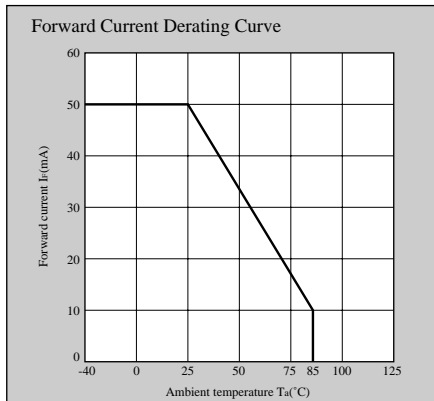
Duty Ratio vs. Peak Forward Current



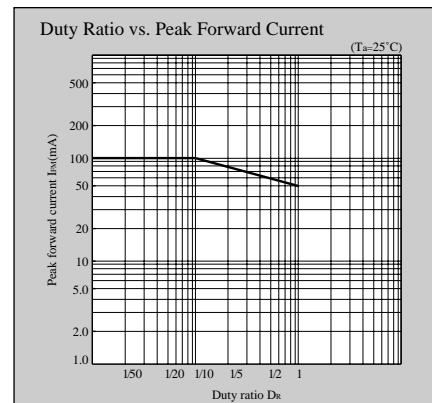
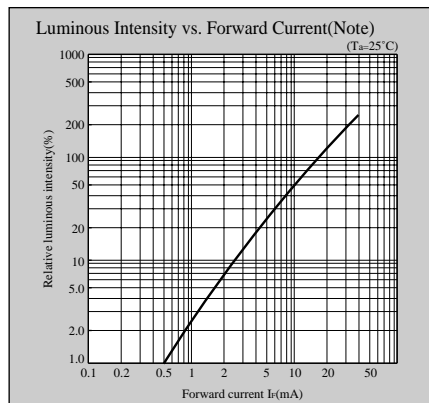
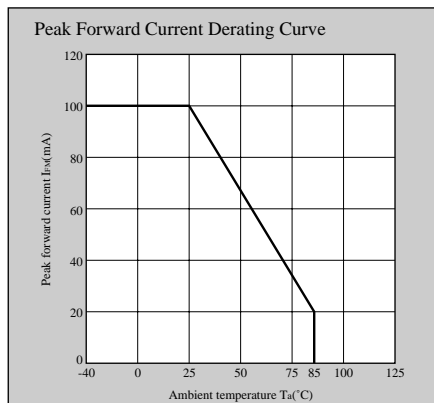
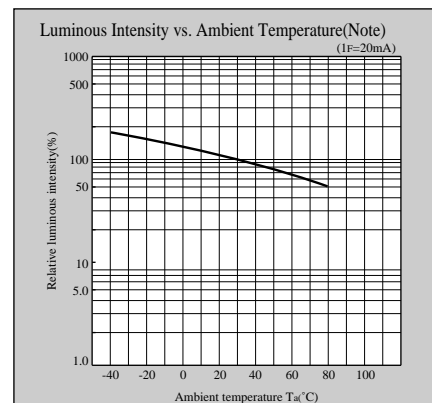
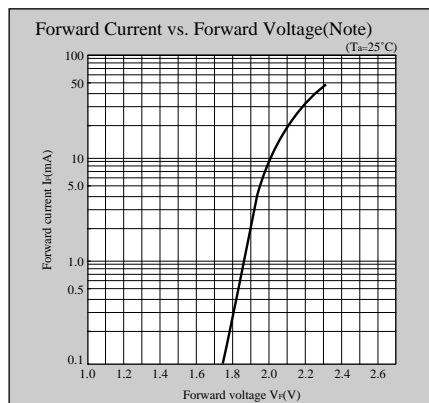
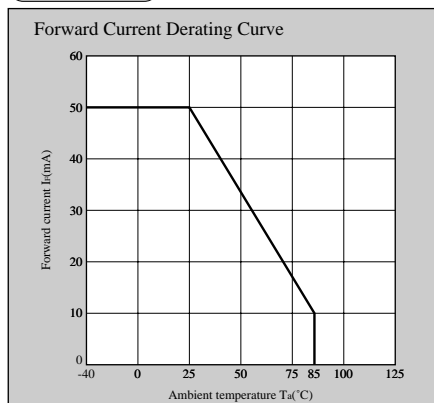
Note) Characteristics shown in diagrams are typical values. (not assurance value)

LED Lamp Characteristics Diagrams

ZV series



ZE series



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